

32-6574-18 Information


For Reference Only

Part Number 32-6574-18
Manufacturer Aries Electronics
Category Connectors, Interconnects
 Sockets for ICs, Transistors
Description CONN IC DIP SOCKET ZIF 32POS TIN
Package -
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


32-6574-18 Specifications

Manufacturer Part Number	32-6574-18
Manufacturer	Aries Electronics
Category	Connectors, Interconnects Sockets for ICs, Transistors
Package	-
Series	57
Type	DIP, ZIF (ZIP), 0.6" (15.24mm) Row Spacing
Number of Positions or Pins (Grid)	32 (2 x 16)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Tin
Contact Finish Thickness - Mating	200µin (5.08µm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Closed Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Tin
Contact Finish Thickness - Post	200µin (5.08µm)
Contact Material - Post	Beryllium Copper
Housing Material	Polyphenylene Sulfide (PPS), Glass Filled
Operating Temperature	-

[Report errors?](#)

32-6574-18 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

32-6574-18 Payment Methods



32-6574-18 Shipping Methods



If you have any question about 32-6574-18, please do not hesitate to contact us!

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